



First Semiconductor

N-Channel Enhancement Mode Power Mosfet

FIR75N06PG

Description

The FIR75N06PG uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

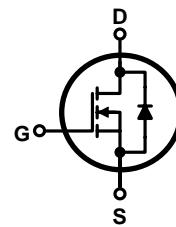
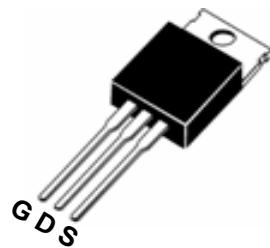
General Features

- $V_{DS} = 60V, I_D = 75A$
- $R_{DS(ON)} < 11.5m\Omega @ V_{GS}=10V$ (Typ:9.1mΩ)
- High density cell design for ultra low $R_{DS(on)}$
- Fully characterized Avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Power switching application
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply

PIN Connection TO-220AB



Marking Diagram



Y = Year
 A = Assembly Location
 WW = Work Week
 FIR75N06P = Specific Device Code

Package Marking And Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
FIR75N0P6	FIR75N06PG	TO-220	-	-	-

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous	I_D	75	A
Drain Current-Continuous($T_c=100^\circ C$)	$I_D (100^\circ C)$	50	A
Pulsed Drain Current	I_{DM}	300	A
Maximum Power Dissipation	P_D	110	W
Derating factor		0.73	W/°C
Single pulse avalanche energy (Note 5)	E_{AS}	450	mJ
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 175	°C

**Thermal Characteristic**

Thermal Resistance,Junction-to-Case(Note 2)	$R_{\theta JC}$	1.36	$^{\circ}\text{C}/\text{W}$
---	-----------------	------	-----------------------------

Electrical Characteristics (TA=25°C unless otherwise noted)

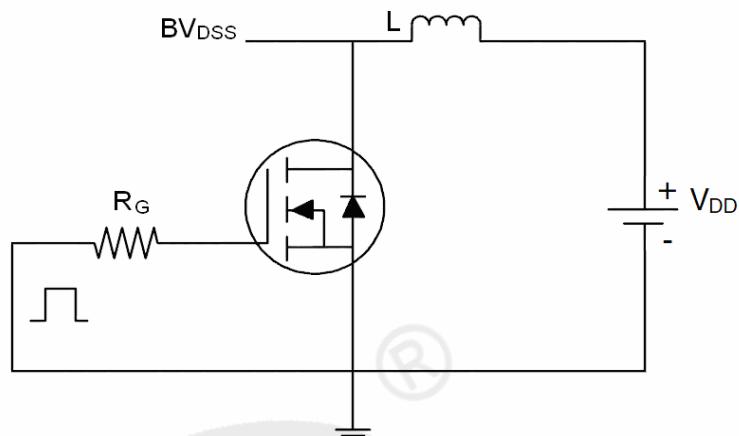
Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	60	68	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}}=60\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2	3	4	V
Drain-Source On-State Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=30\text{A}$	-	9.1	11.5	$\text{m}\Omega$
Forward Transconductance	g_{FS}	$V_{\text{DS}}=25\text{V}, I_{\text{D}}=30\text{A}$	20	-	-	S
Dynamic Characteristics (Note 4)						
Input Capacitance	C_{iss}	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, F=1.0\text{MHz}$	-	2350	-	PF
Output Capacitance	C_{oss}		-	237	-	PF
Reverse Transfer Capacitance	C_{rss}		-	205	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	$t_{\text{d(on)}}$	$V_{\text{DD}}=30\text{V}, I_{\text{D}}=2\text{A}, R_{\text{L}}=15\Omega$ $V_{\text{GS}}=10\text{V}, R_{\text{G}}=2.5\Omega$	-	16	-	nS
Turn-on Rise Time	t_{r}		-	10	-	nS
Turn-Off Delay Time	$t_{\text{d(off)}}$		-	45	-	nS
Turn-Off Fall Time	t_{f}		-	12	-	nS
Total Gate Charge	Q_{g}	$V_{\text{DS}}=30\text{V}, I_{\text{D}}=30\text{A}, V_{\text{GS}}=10\text{V}$	-	50	-	nC
Gate-Source Charge	Q_{gs}		-	12	-	nC
Gate-Drain Charge	Q_{gd}		-	16	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V_{SD}	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=30\text{A}$	-	-	1.2	V
Diode Forward Current (Note 2)	I_{S}		-	-	75	A
Reverse Recovery Time	t_{rr}	$T_{\text{J}} = 25^{\circ}\text{C}, \text{IF} = 75\text{A}$ $dI/dt = 100\text{A}/\mu\text{s}$ (Note 3)	-	28		nS
Reverse Recovery Charge	Q_{rr}		-	49		nC
Forward Turn-On Time	t_{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

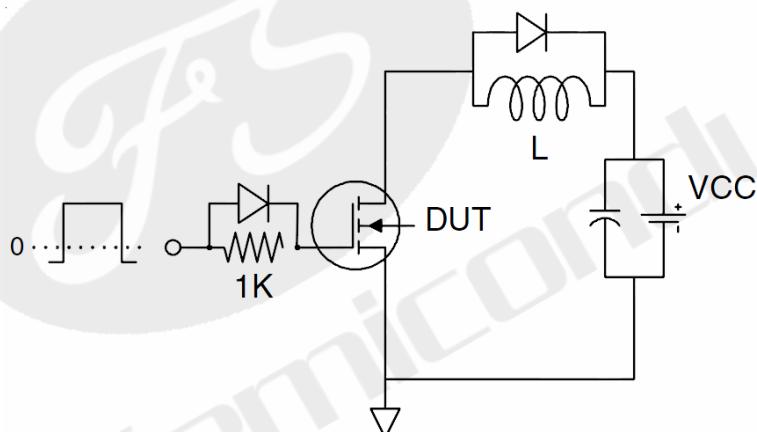
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production
5. EAS condition: $T_{\text{J}}=25^{\circ}\text{C}, V_{\text{DD}}=30\text{V}, V_{\text{G}}=10\text{V}, L=0.5\text{mH}, R_{\text{G}}=25\Omega$

Test circuit

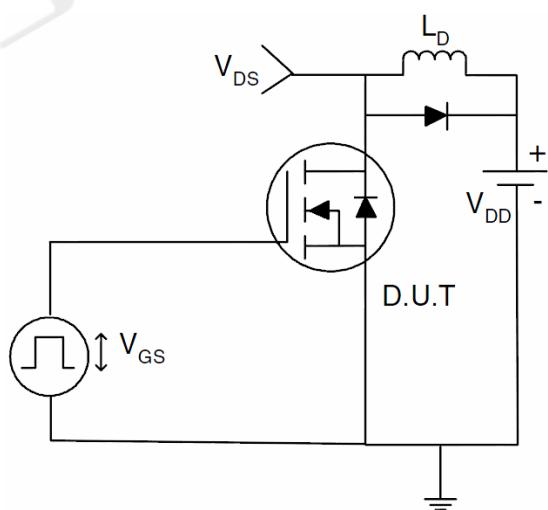
1) E_{AS} test Circuits



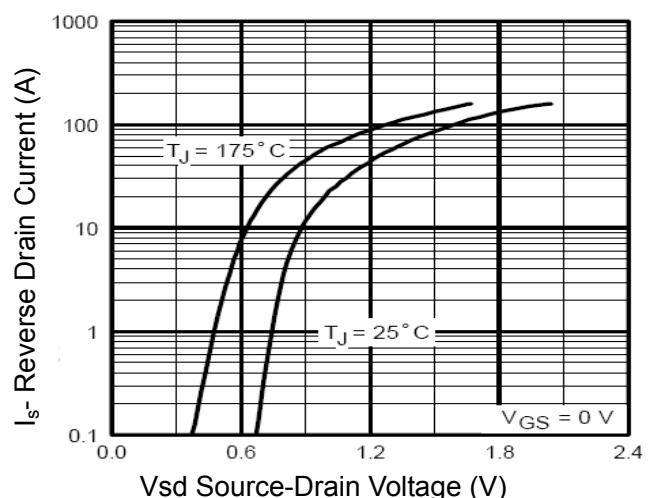
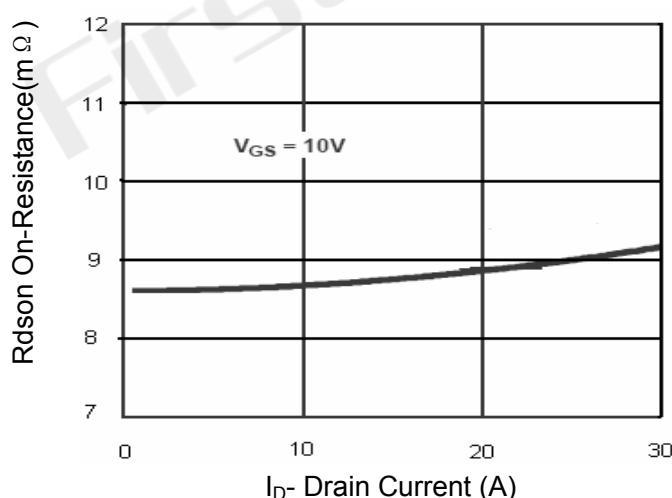
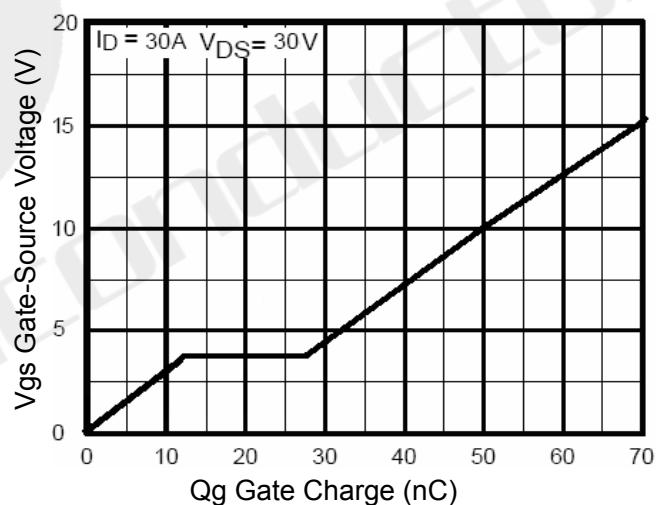
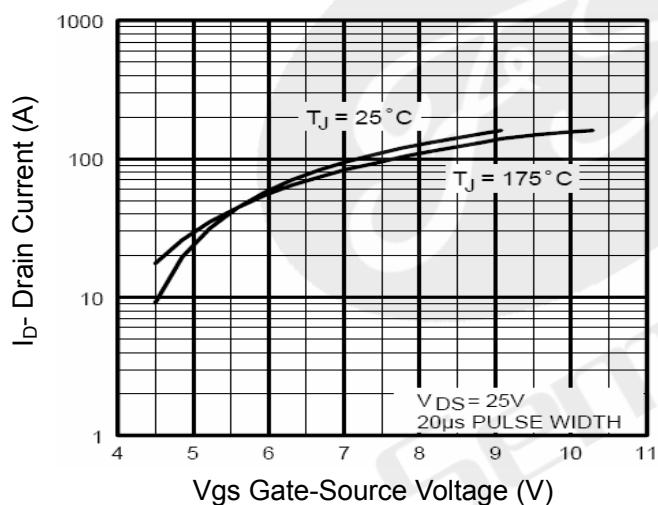
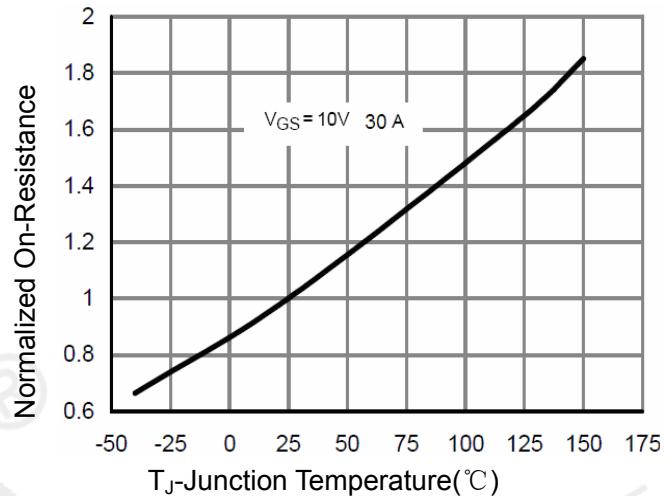
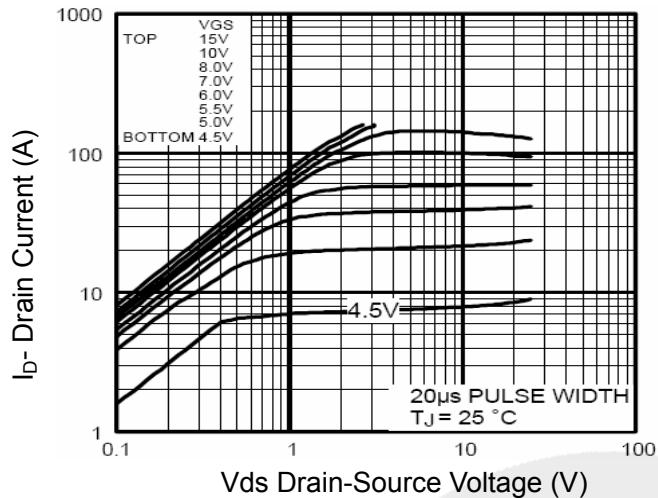
2) Gate charge test Circuit:



3) Switch Time Test Circuit:



Typical Electrical And Thermal Characteristics(Curves)



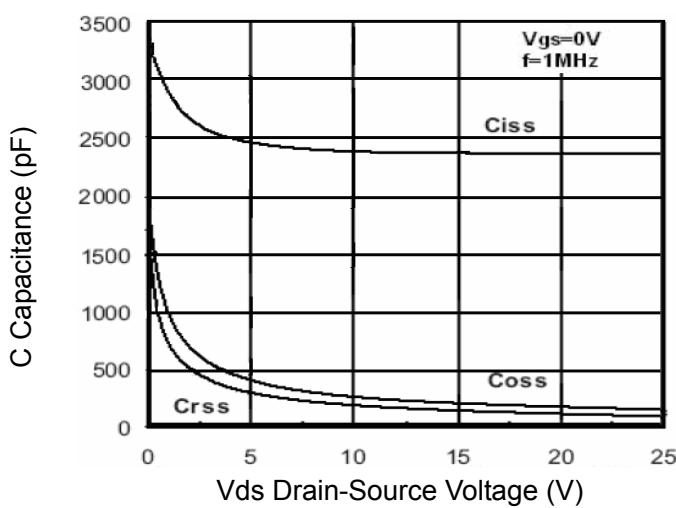


Figure 7 Capacitance vs Vds

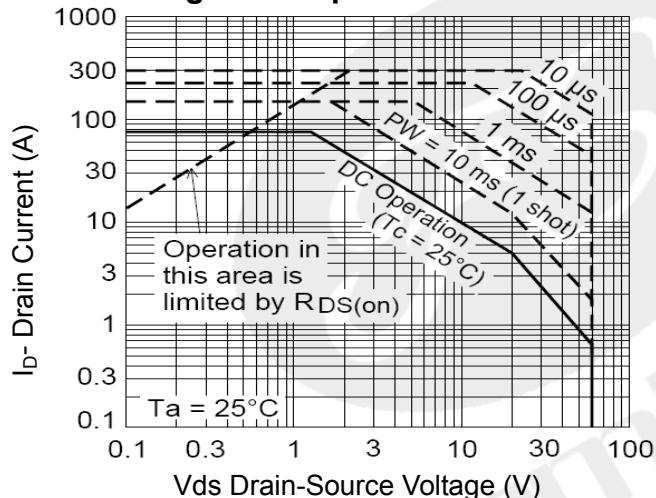


Figure 8 Safe Operation Area

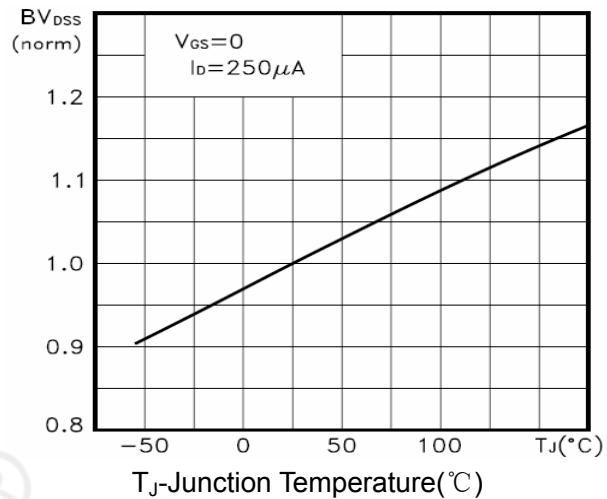
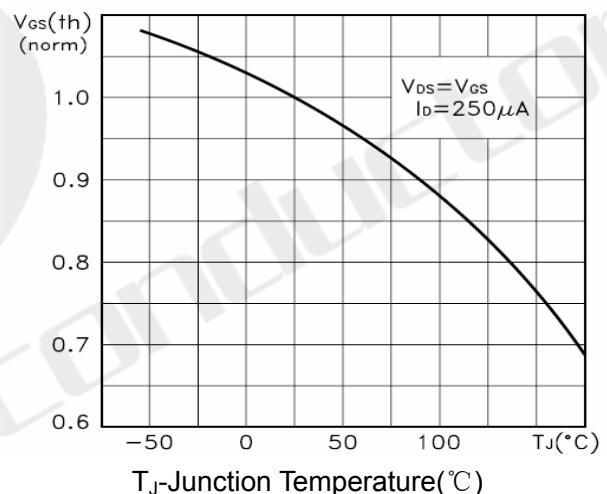
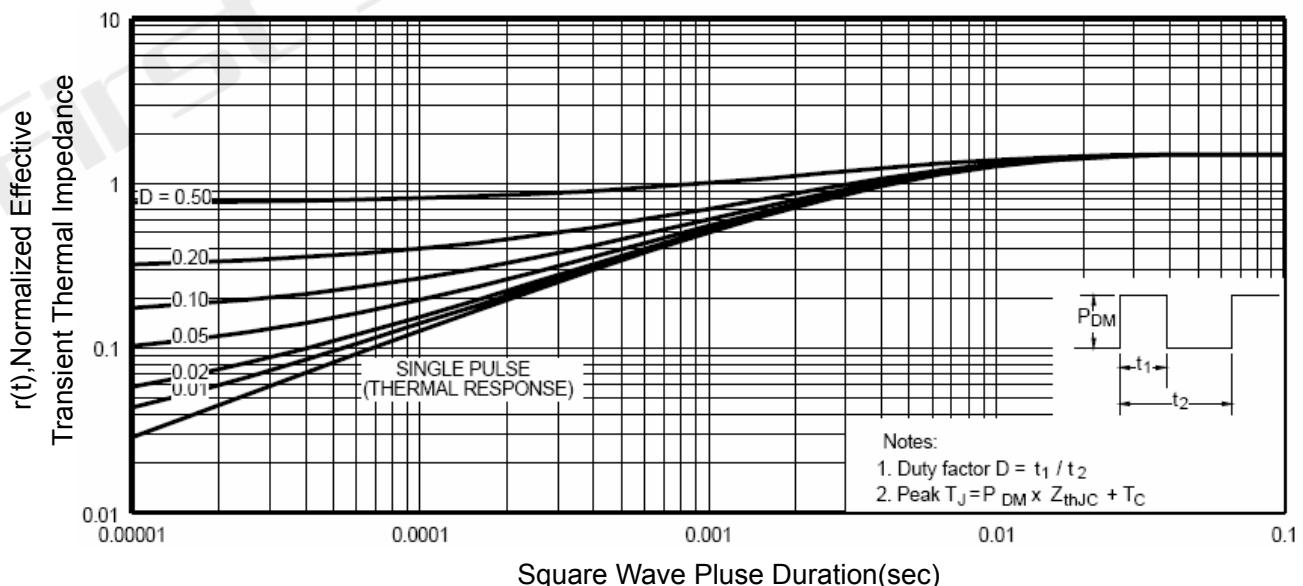
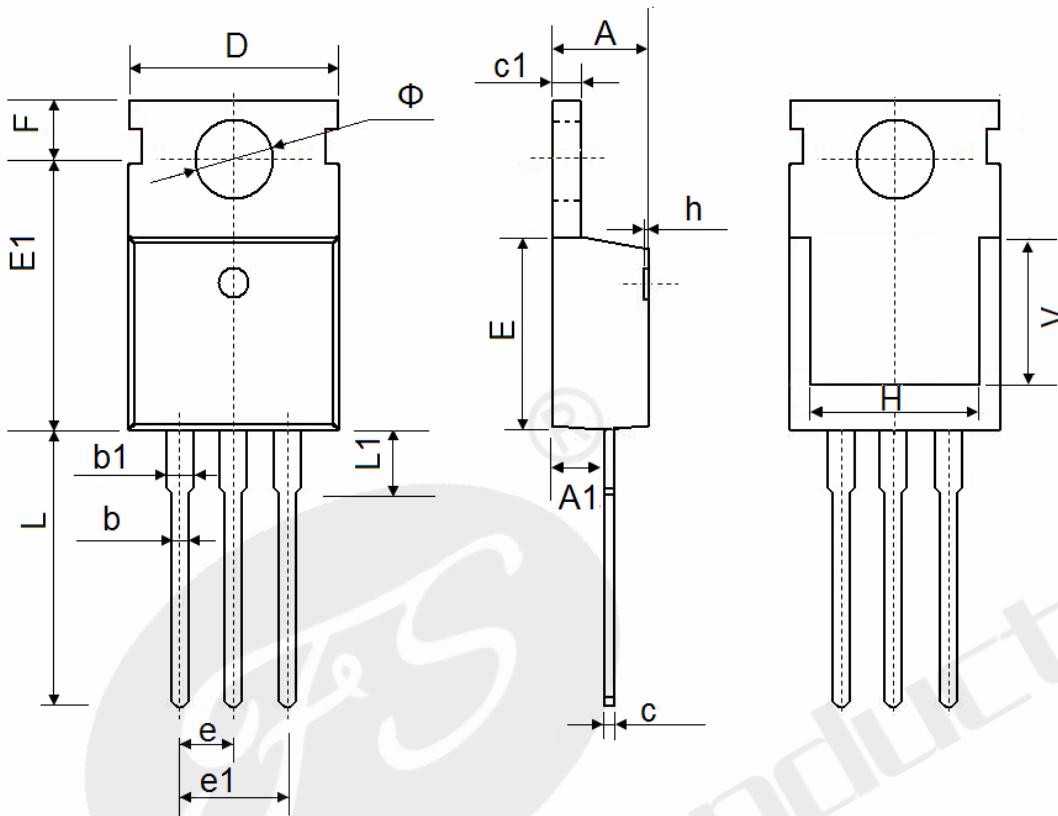

 Figure 9 BV_{DSS} vs Junction Temperature

 Figure 10 $V_{GS(th)}$ vs Junction Temperature


Figure 11 Normalized Maximum Transient Thermal Impedance

TO-220AB Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.400	4.600	0.173	0.181
A1	2.250	2.550	0.089	0.100
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.330	0.650	0.013	0.026
c1	1.200	1.400	0.047	0.055
D	9.910	10.250	0.390	0.404
E	8.9500	9.750	0.352	0.384
E1	12.650	12.950	0.498	0.510
e	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204
F	2.650	2.950	0.104	0.116
H	7.900	8.100	0.311	0.319
h	0.000	0.300	0.000	0.012
L	12.900	13.400	0.508	0.528
L1	2.850	3.250	0.112	0.128
V	7.500 REF.		0.295 REF.	
Φ	3.400	3.800	0.134	0.150



Declaration

- FIRST reserves the right to change the specifications, the same specifications of products due to different packaging line mold, the size of the appearance will be slightly different, shipped in kind, without notice! Customers should obtain the latest version information before ordering, and verify whether the relevant information is complete and up-to-date.
- Any semiconductor product under certain conditions has the possibility of failure or failure, The buyer has the responsibility to comply with safety standards and take safety measures when using FIRST products for system design and manufacturing, To avoid potential failure risks, which may cause personal injury or property damage!
- Product promotion endless, our company will wholeheartedly provide customers with better products!

ATTACHMENT

Revision History

Date	REV	Description	Page
2018.01.01	1.0	Initial release	